

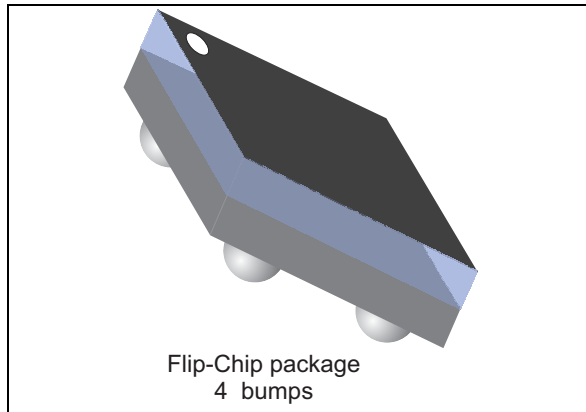


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50 ohm, conjugate match to CC253x, CC254x, CC257x, CC852x, CC853x, transformer balun

Datasheet — production data



Description

STMicroelectronics BAL-CC25-01D3 is an ultra miniature balun which integrates a matching network in a monolithic glass substrate. This has been customized for the CC25xx and CC85xx RF transceivers.

It's a design using STMicroelectronics IPD (integrated passive device) technology on non-conductive glass substrate to optimize RF performance.

Features

- 2.45 GHz balun with integrated matching network
- Matching optimized for following chip-sets:
 - CC2530, CC2531, CC2533
 - CC2540, CC2541, CC2541S
 - CC2543, CC2544, CC2545
 - CC2570, CC2571
 - CC8520, CC8521
 - CC8530, CC8531
- Low insertion loss
- Low amplitude imbalance
- Low phase imbalance
- Coated Flip-Chip on glass
- Small footprint: < 0.88 mm²

Benefits

- Very low profile
- High RF performance
- PCB space saving versus discrete solution
- BOM count reduction
- Efficient manufacturability

Figure 1. Pin configuration (top view)

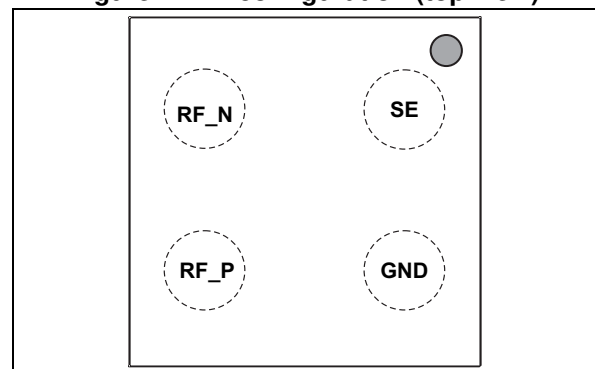
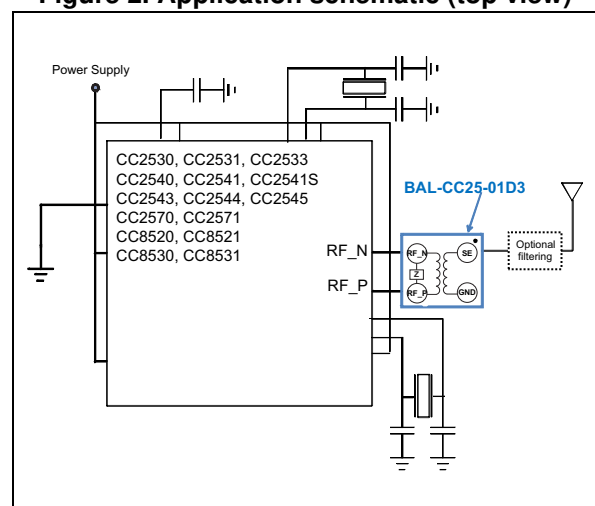


Figure 2. Application schematic (top view)



1 Characteristics

Table 1. Absolute maximum rating (limiting values)

Symbol	Parameter	Value			Unit
		Min.	Typ.	Max.	
P_{PEAK}	Input power RF_{IN}		20		dBm
V_{ESD}	ESD ratings MIL STD883C (HBM: C = 100 pF, R = 1.5 Ω , air discharge)	2000			V
	ESD ratings machine model (MM: C = 200 pF, R = 25 Ω , L = 500 nH)	500			
	ESD ratings charged device model (CDM, JESD22-C101D)	500			
T_{OP}	Operating temperature	-40		+125	$^{\circ}\text{C}$

Table 2. Electrical characteristics - RF performance ($T_{amb} = 25^{\circ}\text{C}$)

Symbol	Parameter	Value			Unit
		Min.	Typ.	Max.	
Z_{OUT}	Nominal differential output impedance	Conjugate match to CC25xx, CC85xx			Ω
Z_{IN}	Nominal input impedance				
F	Frequency range (bandwidth)	2379		2507	
I_L	Insertion loss in bandwidth		0.66		dB
R_{L_SE}	Single ended return loss in bandwidth		19		dB
R_{L_DIFF}	Differential ended return loss in bandwidth		19		dB
Φ_{imb}	Phase imbalance		14		$^{\circ}$
A_{imb}	Amplitude imbalance		0.3		dB

Figure 3. Insertion loss ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

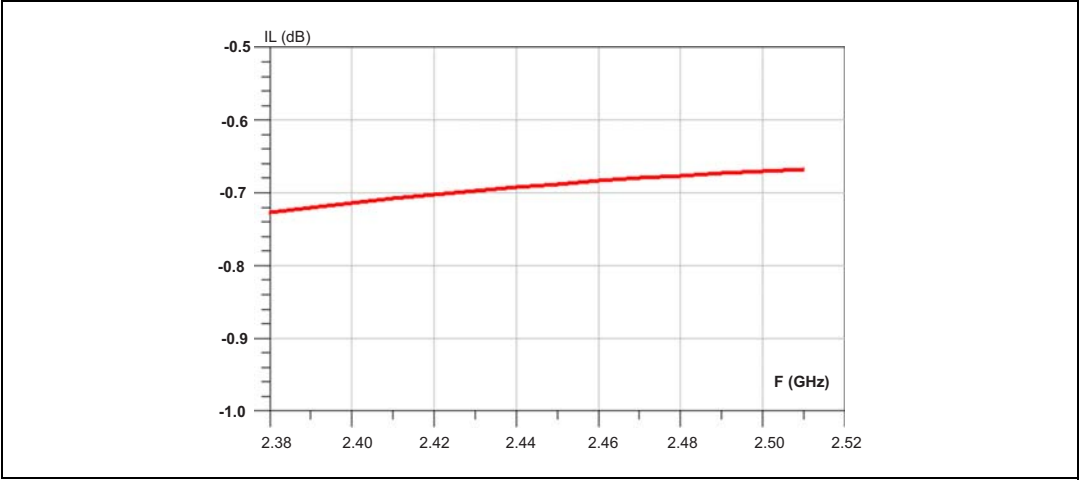


Figure 4. Return loss ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

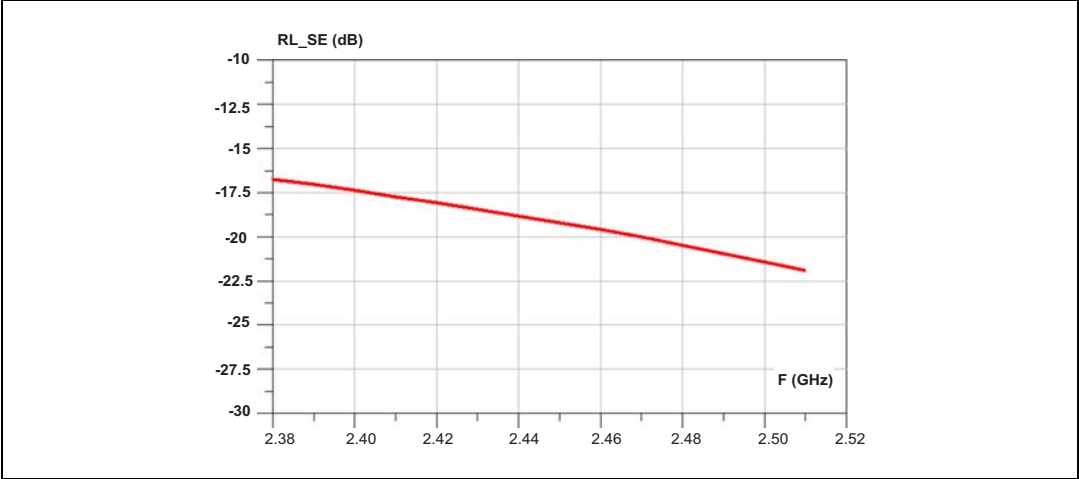


Figure 5. Return loss ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

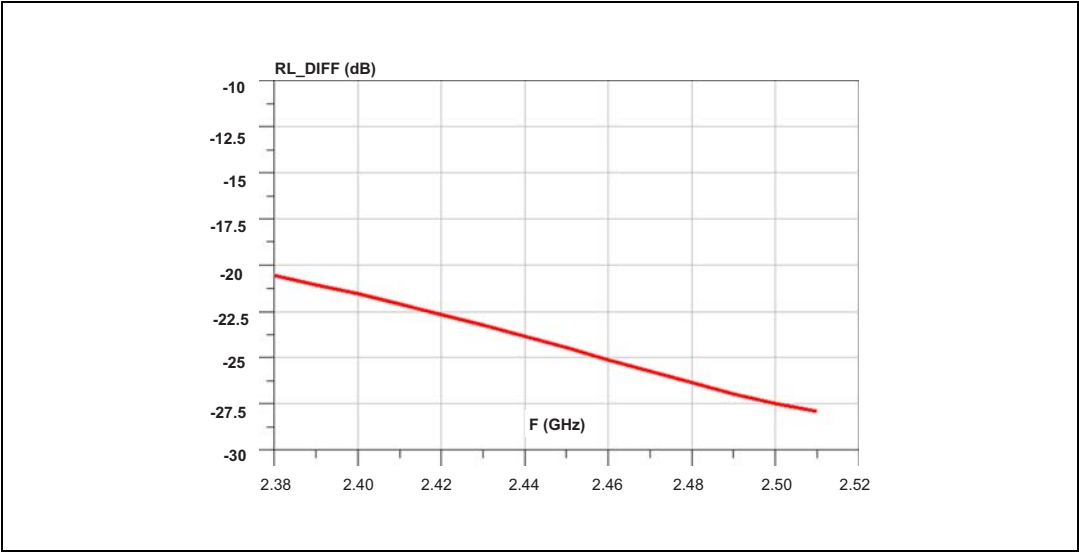


Figure 6. Amplitude imbalance ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

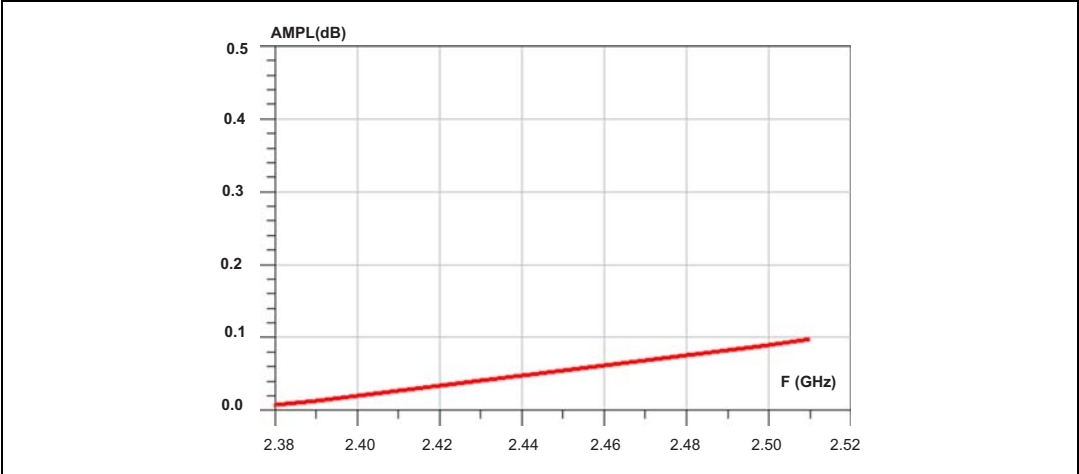
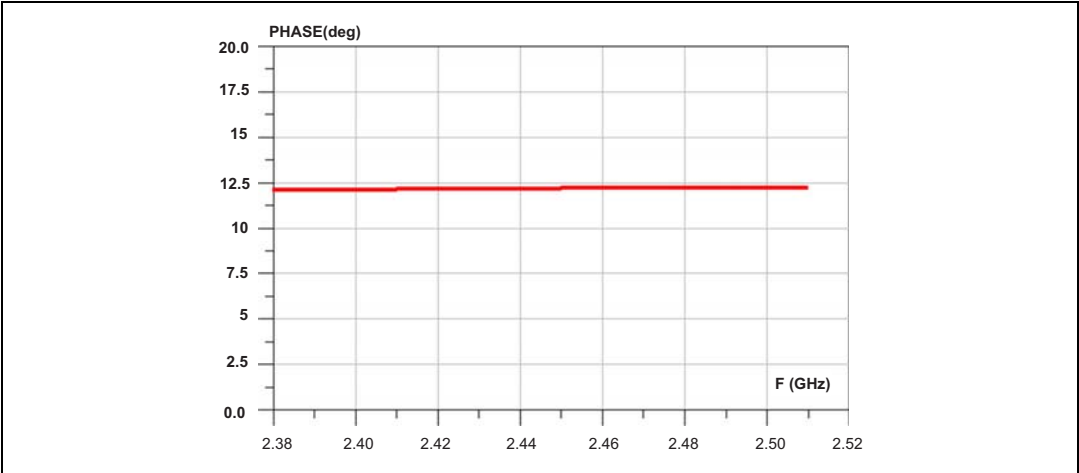


Figure 7. Phase imbalance ($T_{amb} = 25\text{ }^{\circ}\text{C}$)



2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 8. Package dimensions

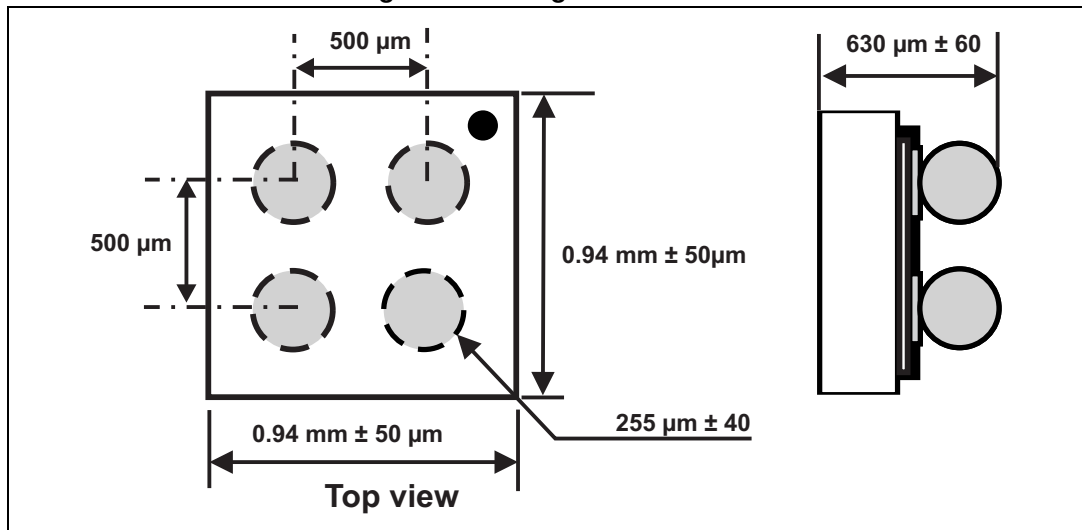


Figure 9. PCB layout recommendation

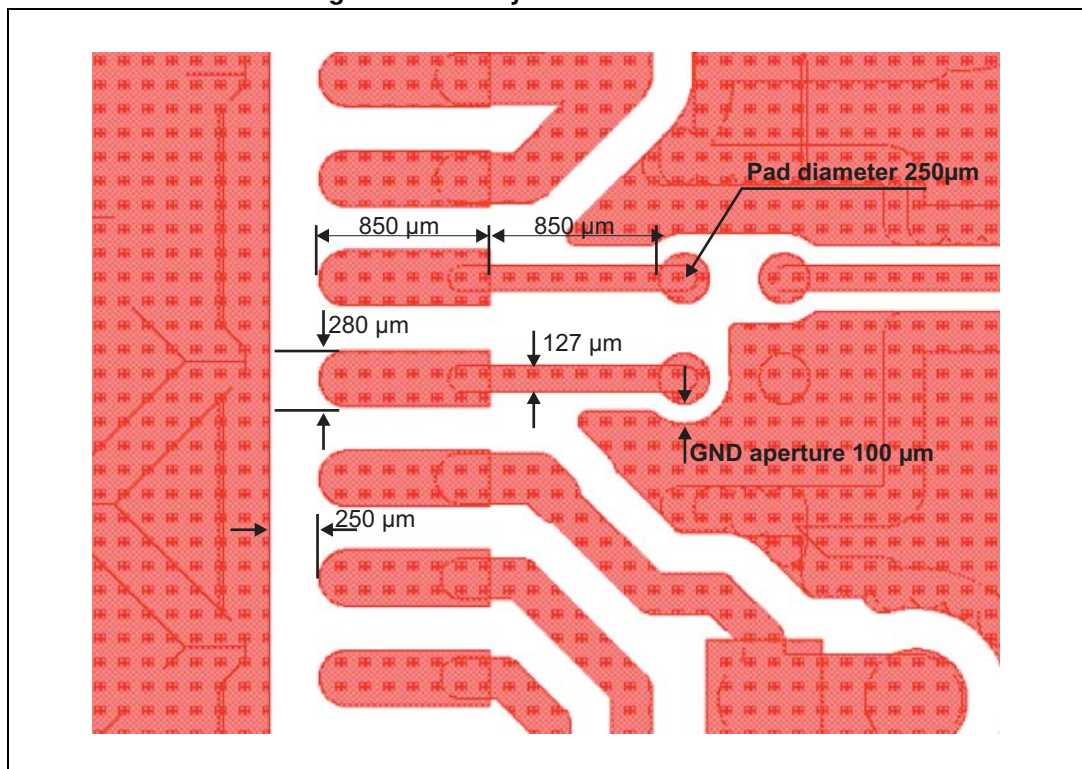


Figure 10. footprint

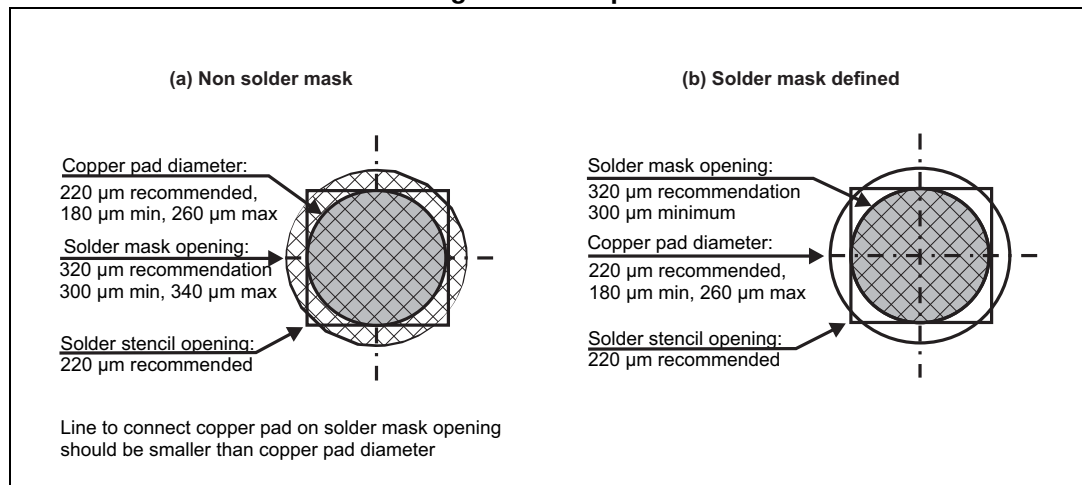


Figure 11. Marking

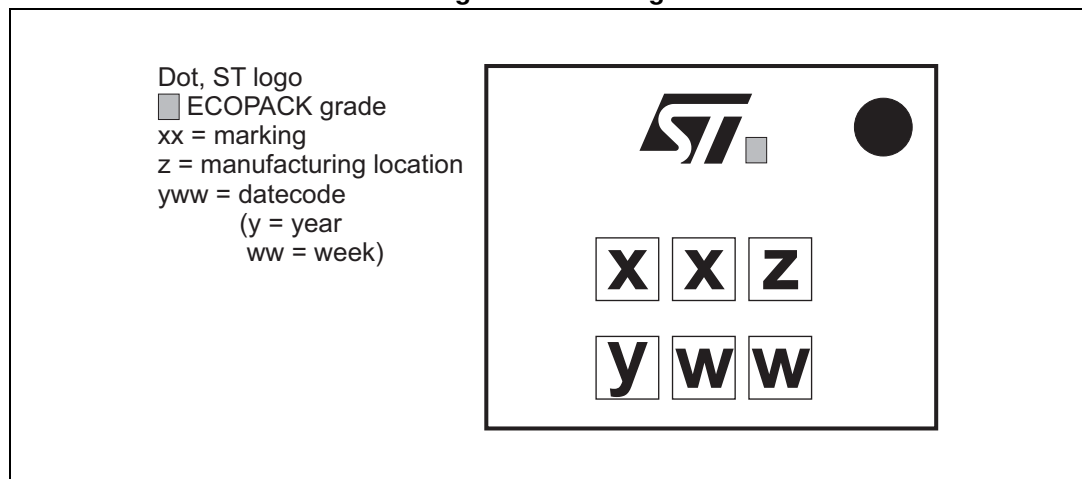
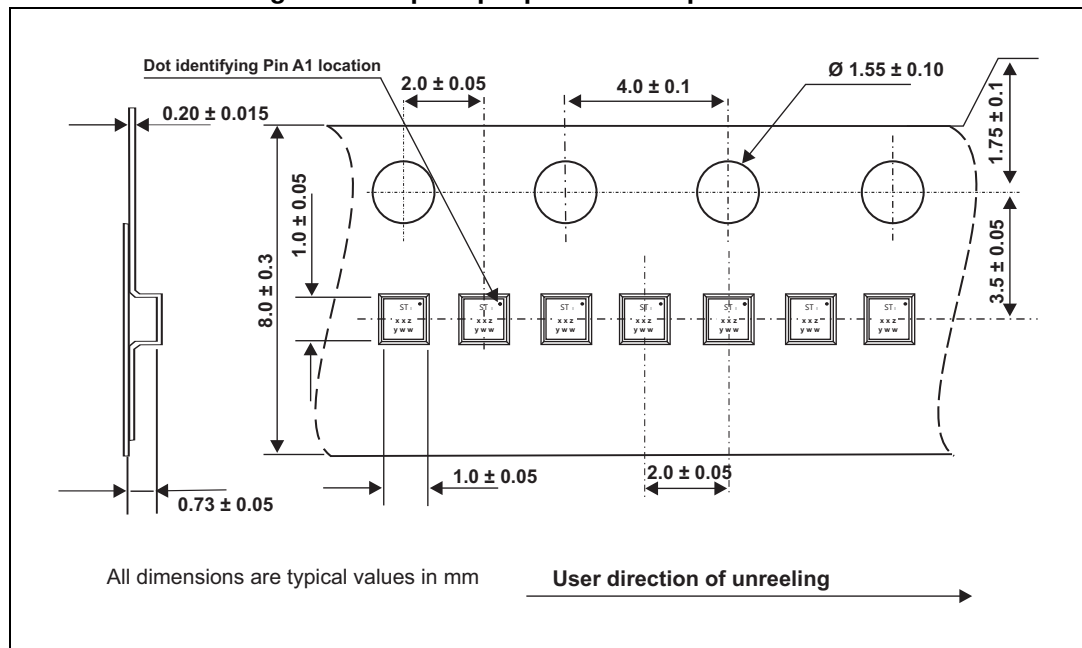


Figure 12. Flip Chip tape and reel specifications



Note: More information is available in the application note:

AN2348: "Flip Chip: package description and recommendations for use"

3 Ordering information

Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
BAL-CC25-01D3	SL	Flip Chip	1.07 mg	5000	Tape and reel (7")

4 Revision history

Table 4. Document revision history

Date	Revision	Changes
23-May-2013	1	Initial release
11-Jul-2013	2	Updated Figure 9 .

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